FAIRCHILD SEMICONDUCTOR™

April 1988
Revised March 2000

74F194
4-Bit Bidirectional Universal Shift Register

General Description

The 74F194 is a high-speed 4-bit bidirectional universal shift register. As a high-speed, multifunctional, sequential building block, it is useful in a wide variety of applications. It may be used in serial-serial, shift left, shift right, serial-parallel, parallel-serial, and parallel-parallel data register transfers.

Features

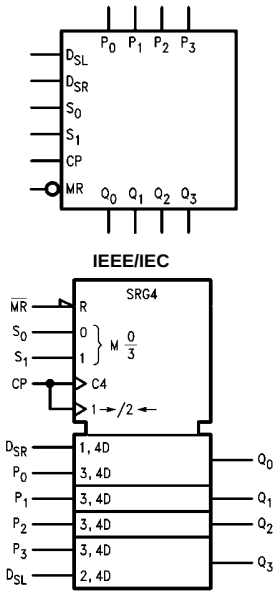
- Typical shift frequency of 150 MHz
- Asynchronous master reset
- Hold (do nothing) mode
- Fully synchronous serial or parallel data transfers

Ordering Code:

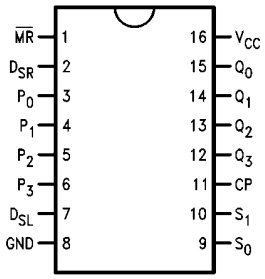
Order Number	Package Number	Package Description
74F194SC	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
74F194SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74F194PC	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbols



Connection Diagram



Unit Loading/Fan Out

Pin Names	Description	U.L. HIGH/LOW	Input I_{IH}/I_{IL} Output I_{OH}/I_{OL}
S_0, S_1	Mode Control Inputs	1.0/1.0	20 µA/–0.6 mA
P_0–P_3	Parallel Data Inputs	1.0/1.0	20 µA/–0.6 mA
D_{SR}	Serial Data Input (Shift Right)	1.0/1.0	20 µA/–0.6 mA
D_{SL}	Serial Data Input (Shift Left)	1.0/1.0	20 µA/–0.6 mA
CP	Clock Pulse Input (Active Rising Edge)	1.0/1.0	20 µA/–0.6 mA
$\overline{MR}$	Asynchronous Master Reset Input (Active LOW)	1.0/1.0	20 µA/–0.6 mA
Q_0–Q_3	Parallel Outputs	50/33.3	–1 mA/20 mA

Functional Description

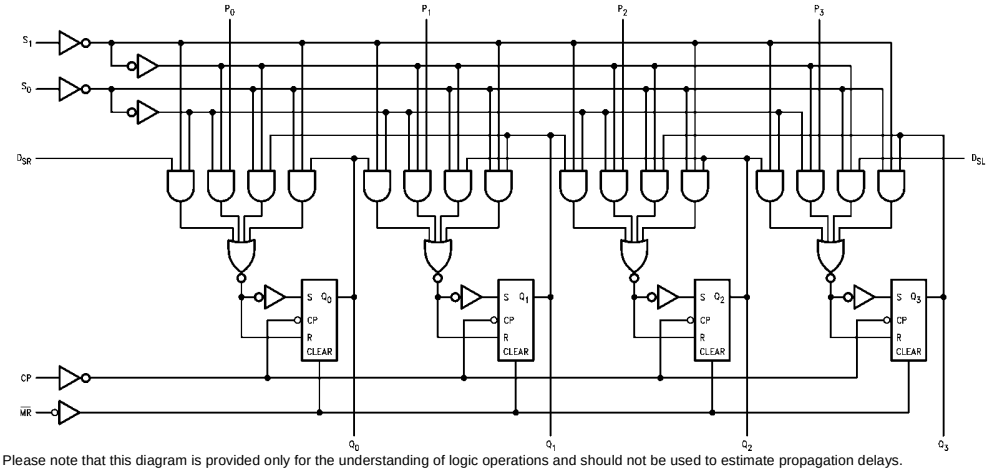
The 74F194 contains four edge-triggered D-type flip-flops and the necessary interstage logic to synchronously perform shift right, shift left, parallel load and hold operations. Signals applied to the Select (S_0, S_1) inputs determine the type of operation, as shown in the Mode Select Table. Signals on the Select, Parallel data (P_0–P_3) and Serial data (D_{SR}, D_{SL}) inputs can change when the clock is in either state, provided only that the recommended setup and hold times, with respect to the clock rising edge, are observed. A LOW signal on Master Reset ($\overline{MR}$) overrides all other inputs and forces the outputs LOW.

Mode Select Table

Operating Mode	Inputs						Outputs			
	$\overline{MR}$	S_1	S_0	D_{SR}	D_{SL}	P_n	Q_0	Q_1	Q_2	Q_3
Reset	L	X	X	X	X	X	L	L	L	L
Hold	H	l	l	X	X	X	q_0	q_1	q_2	q_3
Shift Left	H	h	l	X	l	X	q_1	q_2	q_3	L
	H	h	l	X	h	X	q_1	q_2	q_3	H
Shift Right	H	l	h	l	X	X	L	q_0	q_1	q_2
	H	l	h	h	X	X	H	q_0	q_1	q_2
Parallel Load	H	h	h	X	X	p_n	p_0	p_1	p_2	p_3

H (h) = HIGH Voltage Level
L (l) = LOW Voltage Level
p_n (q_n) = Lower case letters indicate the state of the referenced input (or output) one setup time prior to the LOW-to-HIGH clock transition.
X = Immaterial

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings(Note 1)

Storage Temperature	−65°C to +150°C
Ambient Temperature under Bias	−55°C to +125°C
Junction Temperature under Bias	−55°C to +150°C
V_{CC} Pin Potential to Ground Pin	−0.5V to +7.0V
Input Voltage (Note 2)	−0.5V to +7.0V
Input Current (Note 2)	−30 mA to +5.0 mA
Voltage Applied to Output	
in HIGH State (with V_{CC} = 0V)	
Standard Output	−0.5V to V_{CC}
3-STATE Output	−0.5V to +5.5V
Current Applied to Output	
in LOW State (Max)	twice the rated I_{OL} (mA)

Recommended Operating Conditions

Free Air Ambient Temperature	0°C to +70°C
Supply Voltage	+4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter		Min	Typ	Max	Units	V_{CC}	Conditions
V_{IH}	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal
V_{IL}	Input LOW Voltage				0.8	V		Recognized as a LOW Signal
V_{CD}	Input Clamp Diode Voltage				−1.2	V	Min	I_{IN} = −18 mA
V_{OH}	Output HIGH Voltage	10% V_{CC}	2.5			V	Min	I_{OH} = −1 mA
		5% V_{CC}	2.7					I_{OH} = −1 mA
V_{OL}	Output LOW Voltage	10% V_{CC}			0.5			I_{OL} = 20 mA
I_{IH}	Input HIGH Current				5.0	µA	Max	V_{IN} = 2.7V
I_{BVI}	Input HIGH Current Breakdown Test				7.0	µA	Max	V_{IN} = 7.0V
I_{CEX}	Output HIGH Leakage Current				50	µA	Max	V_{OUT} = V_{CC}
V_{ID}	Input Leakage Test		4.75			V	0.0	I_{ID} = 1.9 µA All Other Pins Grounded
I_{OD}	Output Leakage Circuit Current				3.75	µA	0.0	V_{IOD} = 150 mV All Other Pins Grounded
I_{IL}	Input LOW Current				−0.6	mA	Max	V_{IN} = 0.5V
I_{OS}	Output Short-Circuit Current		−60		−150	mA	Max	V_{OUT} = 0V
I_{CC}	Power Supply Current			33	46	mA	Max	

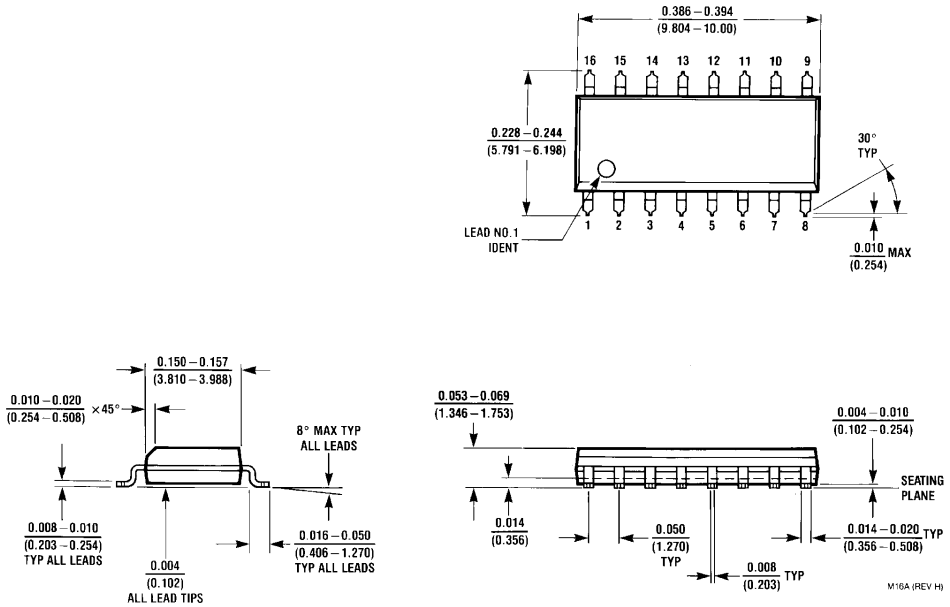
AC Electrical Characteristics

Symbol	Parameter	$T_A = +25°C$, $V_{CC} = +5.0V$, $C_L = 50$ pF			$T_A = -55°C$ to $+125°C$, $V_{CC} = +5.0V$, $C_L = 50$ pF		$T_A = 0°C$ to $+70°C$, $V_{CC} = +5.0V$, $C_L = 50$ pF		Units
		Min	Typ	Max	Min	Max	Min	Max	
f_{MAX}	Maximum Shift Frequency	105	150		90		90		MHz
t_{PLH}	Propagation Delay	3.5	5.2	7.0	3.0	8.5	3.5	8.0	ns
t_{PHL}	CP to Q_n	3.5	5.5	7.0	3.0	8.5	3.5	8.0	
t_{PHL}	Propagation Delay $\overline{MR}$ to Q_n	4.5	8.6	12.0	4.5	14.5	4.5	14.0	ns

AC Operating Requirements

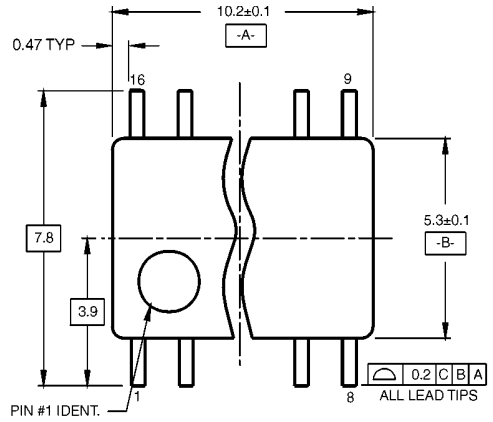
Symbol	Parameter	$T_A = +25°C$, $V_{CC} = +5.0V$		$T_A = -55°C$ to $+125°C$, $V_{CC} = +5.0V$		$T_A = 0°C$ to $+70°C$, $V_{CC} = +5.0V$		Units
		Min	Max	Min	Max	Min	Max	
$t_S(H)$	Setup Time, HIGH or LOW	4.0		6.0		4.0		ns
$t_S(L)$	P_n or D_{SR} or D_{SL} to CP	4.0		4.0		4.0		
$t_H(H)$	Hold Time, HIGH or LOW	1.0		1.5		1.0		
$t_H(L)$	P_n or D_{SR} or D_{SL} to CP	0		1.0		1.0		
$t_S(H)$	Setup Time, HIGH or LOW	10.0		10.5		11.0		ns
$t_S(L)$	S_n to CP	8.0		8.0		8.0		
$t_H(H)$	Hold Time, HIGH or LOW	0		0		0		
$t_H(L)$	S_n to CP	0		0		0		
$t_W(H)$	CP Pulse Width, HIGH	5.0		5.5		5.5		ns
$t_W(L)$	$\overline{MR}$ Pulse Width, LOW	5.0		5.0		5.0		ns
t_{REC}	Recovery Time $\overline{MR}$ to CP	9.0		9.0		11.0		ns

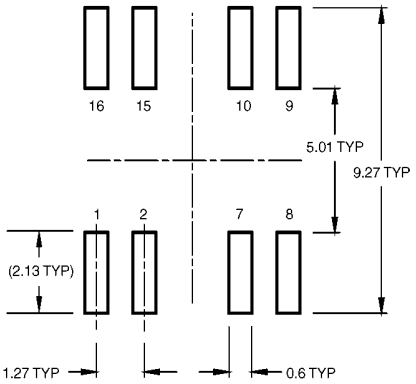
Physical Dimensions inches (millimeters) unless otherwise noted



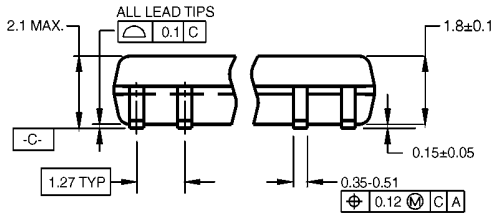
16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
Package Number M16A

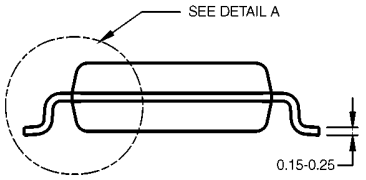
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



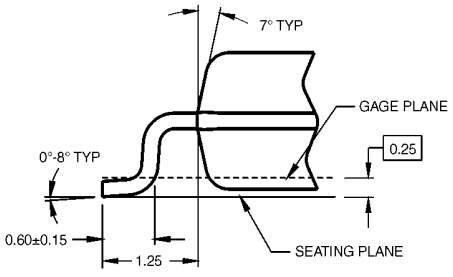


LAND PATTERN RECOMMENDATION





DIMENSIONS ARE IN MILLIMETERS



DETAIL A

NOTES:

A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.

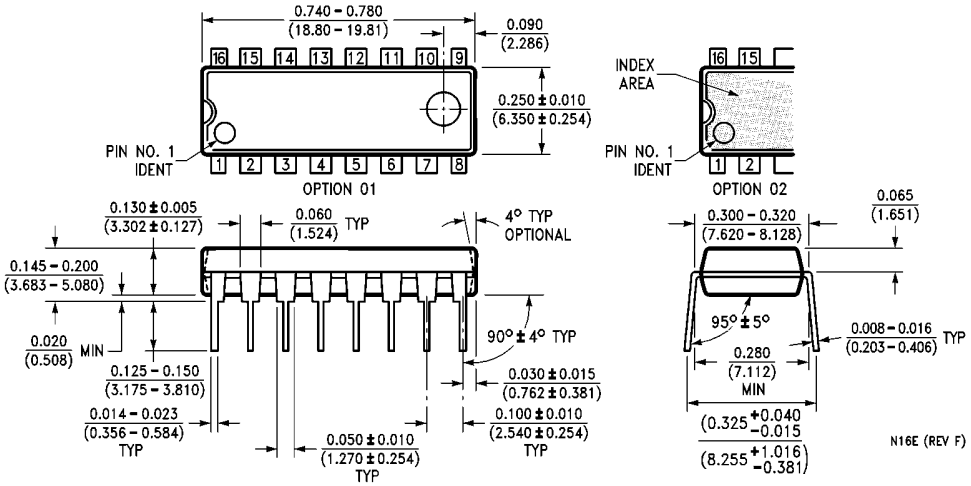
B. DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M16DRevB1

16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M16D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N16E